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# Conservation laws of the $J_k$ -vector for microcrack damage in piezoelectric materials

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## Abstract

This paper focuses on characterizing damaged anisotropic piezoelectric materials by using the principles of fracture mechanics. The interpretation and evaluation of the two components of the  $J_k$ -vector along contours enclosing strongly interacting microcracks in two-dimensional piezoelectric materials are presented. The conservation laws of the  $J_k$ -vector established by Budiansky and Rice (ASME J. Appl. Mech. 40 (1973) 201) for traditional non-piezoelectric materials and extended by Chen and Hasebe (Int. J. Fract. 89 (1998) 333) and Chen (Int. J. Solids Struct. 38 (2000a) 3193 and 38 (2000b) 3213) for interacting multiple cracks are reexamined for anisotropic piezoelectric materials containing interacting multiple cracks. The interaction problem for arrays of arbitrarily orientated and distributed microcracks subjected to mechanical and electrical loading is studied in detail. The contribution of the second component of the  $J_k$ -vector, evaluated in the local coordinate system that is attached to each microcrack, to the  $J_k$ -vector evaluated in the global coordinate system is calculated. It is found that the conservation laws of the  $J_k$ -vector are still valid in damaged piezoelectric materials, although in the present problem the elastic and electric fields are coupled which add complications to the original formulations by Budiansky and Rice. In other words, the total contributions from the microcracks to both components of the  $J_k$ -vector evaluated in the global system vanish, provided that the selected closed contour encloses all microcracks and/or discontinuities. © 2001 Published by Elsevier Science Ltd.

**Keywords:** Conservation laws; Microcrack damage;  $J$ -integral; Piezoelectric ceramics; Interacting cracks; Stress intensity factors; Electric displacement intensity factors; Crack shielding

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## 1. Introduction

Cracks-like defects are abundant in piezoelectric materials, and have been the subject of intensive study in the past decade (Pak, 1990; Sosa, 1991, 1992; Suo et al. 1992; Pak and Tobin, 1993; Dunn, 1994; Park and Sun, 1995a,b; Sosa and Khutoryansky, 1996; Shido et al. 1997; Chung and Ting, 1996; Heyer et al. 1998; Park et al. 1998; Xu and Rajapakse, 1999). Recently, Han and Chen (1999) developed a ‘pseudo-traction-electric displacement’ method to solve the problem of interacting multiple parallel cracks for transversely isotropic piezoelectric materials. It is shown that, due to crack interactions, the stress intensity

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factors (SIFs) at each crack tip are no longer independent of remote electric loadings, in contrary to those for single crack problems (Park and Sun, 1995a,b). The formation of multiple parallel cracks next to a single crack not only relaxes the residual stresses but also disturbs the electric field in the vicinity of the crack. It is the latter source that leads to the indirect but significant influence of electric loadings on the SIFs as well as on the mechanical-strain-energy release rate (MSERR). The work of Han and Chen (1999) is an initial attempt to solve the more general crack-interaction problems, as only the first component of the  $J_k$ -vector is concerned due to the assumption that the multiple cracks are parallel with each other and perpendicular to the poling direction of the piezoelectric ceramics. For multiple cracks arbitrarily oriented and distributed in a piezoelectric such that they are not necessarily perpendicular to the poling direction of the material, the role of electric loading is unclear. Moreover, the validity of the conservation laws of the  $J_k$ -vector in such situations needs to be established since Chen (2000a,b) has shown that the second component of the vector must be considered if the interacting cracks are no longer parallel.

This paper presents an analytical and numerical study of and conservation laws of the  $J_k$ -vector (Budiansky and Rice, 1973) and their application, for strongly interacting and arbitrarily oriented microcracks in two-dimensional (2-D) anisotropic piezoelectric materials. Following Suo et al. (1992), the physical interpretation of the second component of the  $J_k$ -vector in such materials is established. The problem is reduced to a system of integral equations, which are subsequently solved numerically by using the Chebyshev integration technique. The conservation laws of the  $J_k$ -vector established for non-piezoelectric materials (Budiansky and Rice, 1973; Chen and Hasebe, 1998) are reexamined for the present interacting problem in piezoelectric materials; numerical results for a PTZ-4 ceramic are given to complement the analytical work. It is found that the total contributions from a cloud of microcracks in 2-D piezoelectric materials to each component of the  $J_k$ -vector evaluated in a global system vanish, if the closed contour encloses all microcracks.

## 2. $J_k$ -vector: physical interpretation and conservation laws

### 2.1. Path independence of $J_k$ -vector

For a plane crack in a 2-D anisotropic piezoelectric material, the  $J$ -integral is given by (Suo et al., 1992):

$$J = \oint_C \left[ \left( \frac{1}{2} \sigma_{ij} \varepsilon_{ij} dx_2 - n_i \sigma_{ip} \frac{\partial u_p}{\partial x_1} ds \right) - \left( \frac{1}{2} D_i E_i dx_2 + n_i D_i \frac{\partial \phi}{\partial x_1} ds \right) \right] \quad (1)$$

where  $C$  refers to a closed contour starting from one point on the lower surface of the crack and ending at another point on the upper surface of the crack, and  $\sigma_{ij}$ ,  $\varepsilon_{ij}$ ,  $u_p$ ,  $D_i$ ,  $E_i$ , and  $\phi$  are the stresses, strains, displacements, electric displacements, electric field components, and electric potential, respectively. Here,  $i, j, p = 1$  and  $2$ ,  $n_i$  is the outer normal to the contour  $C$ , and  $(x_1, x_2)$  is the Cartesian coordinate system.

By comparing Eq. (1) with the original interpretation of the  $J$ -integral by Rice (1968) for non-piezoelectric materials, it is seen that the first two terms in Eq. (1) contributed by the mechanical quantities are identical to those in Rice's formulation, and the last two terms are additional ones introduced to account for the contributions from the electric quantities. In other words, although the electric and mechanical quantities are coupled in the constitutive equations for piezoelectric materials (see e.g., Suo et al., 1992), they are not directly linked together in Eq. (1).

According to Budiansky and Rice (1973), the  $J$ -integral is only the first component of the  $J_k$ -vector ( $k = 1, 2$ ), which is parallel to the crack surfaces and will be denoted below by  $J_1$ . The second component denoted by  $J_2$  is perpendicular to the crack surfaces and can be introduced in a similar way as  $J_1$ :

$$J_2 = \oint_C \left[ \left( -\frac{1}{2} \sigma_{ij} \varepsilon_{ij} dx_1 - n_i \sigma_{ip} \frac{\partial u_p}{\partial x_2} ds \right) - \left( -\frac{1}{2} D_i E_i dx_1 + n_i D_i \frac{\partial \phi}{\partial x_2} ds \right) \right] \quad (2)$$

Note that the  $J_2$ -integral is in general path-dependent when the integral contour  $C$  encloses only one single tip of a crack. It is therefore likely to be far from significant as it would be in brittle materials (Herrmann and Herrmann, 1981). However, recent investigations of Chen and Ma (1997) and Chen and Hasebe (1998) reveal that, for multiple crack interaction problems in traditional non-piezoelectric materials, the  $J_2$ -integral plays a role similar to that of  $J_1$ . This conclusion is reached by assuming, as suggested by Herrmann and Herrmann (1981), that the closed contour selected for calculating the  $J_2$ -integral encloses either one single crack completely or all cracks present in the material. Under this assumption, both components of the  $J_k$ -vector are then path independent and hence have equal physical significance.

## 2.2. Conservation laws: statement

The new conservation laws of the  $J_k$ -vector for a 2-D piezoelectric material containing one or more cracks/discontinuities can be stated as: the total contributions to both  $J_1$ - and  $J_2$ -integrals evaluated along a closed path  $C_0$  (Fig. 1) enclosing either a single crack/discontinuity completely or all cracks/discontinuities vanish. Mathematically, this can be written as:

$$\sum_{l=1}^N J_{1(l)} = 0 \quad (3)$$

$$\sum_{l=1}^N J_{2(l)} = 0 \quad (4)$$

where  $N$  refers to the total number of cracks/discontinuities in the material, and the subscript  $l$  refers to the  $l$ th crack such that  $J_{1(l)}$  and  $J_{2(l)}$  denote the contributions of the  $l$ th crack to the first and second components of the  $J_k$ -vector evaluated in a global system  $(x_1, x_2)$ . The contribution of the  $l$ th crack evaluated in a local system  $(x_1^l, x_2^l)$  to the  $J_k$ -vector, denoted separately by  $J_{1(l)}^l$  and  $J_{2(l)}^l$  (Fig. 1), are related to  $J_{1(l)}$  and  $J_{2(l)}$  by:

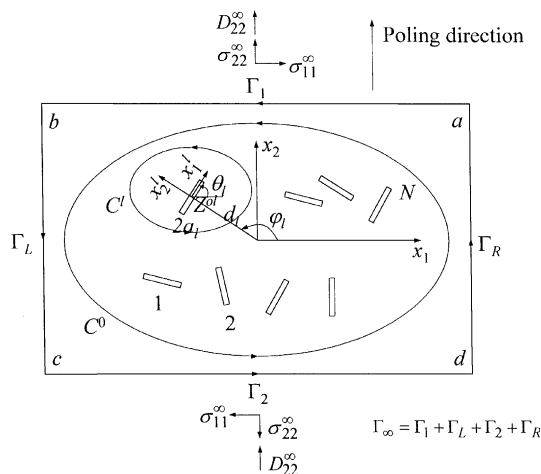


Fig. 1. Geometry and conventions for a cloud of randomly distributed and oriented interacting cracks in an infinite piezoelectric solid subjected to combined mechanical and electric loadings.

$$J_{1(l)} = J_{1(l)}^l \cos \theta_l - J_{2(l)}^l \sin \theta_l \quad (5)$$

$$J_{2(l)} = J_{1(l)}^l \sin \theta_l + J_{2(l)}^l \cos \theta_l \quad (6)$$

where the superscript  $l$  is used to denote quantities that are evaluated in the local system  $(x_1^l, x_2^l)$ , and  $\theta_l$  is the orientation angle of the crack measured from the  $x_1$ -axis to the  $x_1^l$ -axis (Fig. 1).

Eqs. (3)–(6) provide the new conservation laws of the  $J_k$ -vector in strongly interacting multiple crack problems for piezoelectric materials, which show quite different aspects from those customarily used in single crack problems for traditional non-piezoelectric materials (see, e.g., Rice, 1968, Budiansky and Rice, 1973, Herrmann and Herrmann, 1981). These have already been proved numerically (Chen and Hasebe, 1998) and analytically (Chen, 2000a) for non-piezoelectric brittle materials. Because Eqs. (5) and (6) are concerned with the projected relations of the  $J_k$ -vector between its values in the local system and those in the global system (Fig. 1), they may also be termed as *the projected conservation laws of the  $J_k$ -vector* for strongly interacting cracks in a 2-D solid. For anisotropic piezoelectric materials, the conservation laws (3)–(6) should be re-examined since the elastic and electric fields are coupled and the displacements and electric displacements add complications to the original formulations of the vector by Budiansky and Rice (1973).

### 2.3. Mathematical proof of conservation laws

#### 2.3.1. Definition of problem and selection of boundary conditions

The multi-crack interacting problem to be solved is shown in Fig. 1, where  $N$  arbitrarily oriented microcracks are distributed in an infinitely large, two dimensional anisotropic piezoelectric solid. Assume that all the microcracks are fully open and not intersecting with each other, and that the distance between the center of a typical microcrack, say the  $l$ th microcrack, and that of its immediate neighbor is of the same order of magnitude as the average length of the microcracks. In other words, the space among the cracks may be smaller than the crack length. Therefore, strong interaction amongst the cracks is expected. With reference to Fig. 1, let  $a_l$  be the half-length of the  $l$ th microcrack,  $\theta_l$  its orientation angle,  $\phi_l$  its location angle, and let  $d_l$  denote the distance of the center of the  $l$ th microcrack to the origin of the global system  $(x_1, x_2)$ . The remote loading conditions are  $\sigma_{22}^\infty$  and  $D_2^\infty$  along the  $x_2$ -axis and  $\sigma_{12}^\infty$  along the  $x_1$ -axis. The poling direction of the piezoelectric material is taken to be parallel to the  $x_2$ -axis but may not always be perpendicular to the microcracks.

For a typical microcrack, three types of electric boundary condition may be used (Pak, 1992; Suo et al., 1992; Hao and Shen, 1994):

(i) Insulation boundary condition (charge free crack or impermeable crack):

$$D_n^+ = D_n^- = 0 \quad (7)$$

(ii) Conduction boundary condition (permeable or continuous crack):

$$D_n^+ = D_n^-, \quad \phi^+ = \phi^- \quad (8)$$

(iii) Mixed boundary condition:

$$D_n^+ = D_n^-, \quad D_n^+(u_n^+ - u_n^-) = \varepsilon_v(\phi^- - \phi^+) \quad (9)$$

where  $D_n^+$  and  $D_n^-$  are the upper and lower boundary values of the electric displacement on the crack,  $\phi^+$  and  $\phi^-$  are the upper and lower boundary values of the electric potential on the crack,  $\varepsilon_v$  is the dielectric permittivity of the medium inside the crack (as a void), and  $u_n^+$  and  $u_n^-$  are the upper and lower boundary values of the displacement on the crack, respectively.

Since the mechanical and electric quantities are coupled and the three different types of crack boundary condition would lead to significantly different behaviors of the energy release rate (ERR), there has been considerable effort to find dominant parameters that govern crack stability and growth in piezoelectric ceramics. For example, Park and Sun (1995a,b) concluded that neither the SIF nor the  $J$ -integral ( $= J_1$ ) are suitable for describing the stability of an insulated crack; the MSERR was proposed as a new fracture parameter. In contrary, Heyer et al. (1998) performed a series of experimental measurements based on the conduction crack condition, and found that the SIF is still a suitable parameter to describe the stability of a conducting crack. On the other hand, Suo et al. (1992) argued that the permeable condition is not realistic as there is always an electric potential drop across a crack. More recently, Xu and Rajapakse (1999) developed a unified formulation for a crack containing either air or vacuum in piezoelectric ceramics. However, despite all these efforts, the true electric boundary condition on the crack surfaces remains an issue to be resolved, and is a topic beyond the scope of this paper. The purpose of this paper is not to clarify the confusion regarding the three types of electric boundary condition but rather to explore if there exist conservation laws in piezoelectric materials containing strongly interacting cracks. If the conservation laws indeed exist, these should be valid irregardless of the type of electric boundary condition selected. Consequently, unless otherwise stated, the insulation boundary condition (7) will be used throughout the remainder of this paper.

### 2.3.2. Mathematical proof

As there has been some doubt about the validity of Eqs. (3) and (4), a detailed proof is given below, the key being the correct use of the remote uniform stress-electric field. Introduce a closed but sufficiently large contour  $\Gamma_\infty = \Gamma_1 + \Gamma_L + \Gamma_2 + \Gamma_R$  surrounding all the cracks, and introduce a smaller closed contour  $C_l$  which only encloses the  $l$ th crack completely (Fig. 1). According to the path-independent nature of the  $J_k$ -integral vector, one has

$$J_1^\infty = \sum_{l=1}^N J_{1(l)} \quad (10a)$$

$$J_2^\infty = \sum_{l=1}^N J_{2(l)} \quad (10b)$$

where the terms on the left hand side are calculated over  $\Gamma_\infty$ , whilst the terms on the right hand side are calculated over  $C_l$  with  $l = 1, 2, \dots, N$ . Since every term in the summation of Eq. (10a) or Eq. (10b) is in general not equal to zero due to strong interaction amongst the cracks, it is not clear whether the summation should vanish, or not, as a number of people have suspected.

In order to take full advantage of the remote uniform stress-electric field, the closed rectangular contour  $\Gamma_\infty$  has been chosen as large as possible. The reason to introduce the rectangular closed contour rather than an arbitrary one is to significantly simplify the mathematical manipulations involved. However, due to the path-independent nature of the vector, the results evaluated along an arbitrary smooth closed contour  $C_0$  (be it large or small, see Fig. 1) should be identical to those calculated over  $\Gamma_\infty$ . It is worth mentioning here that the second component of the vector is also path-independent, because the closed contour is always chosen either to enlose all the cracks or to enclose a single crack completely (Herrmann and Herrmann, 1981).

Since the traction-free surfaces of each crack lead to non-zero contributions to the second component (Herrmann and Herrmann, 1981), the three different types of electric boundary condition will also lead to non-zero contributions to the last two terms of Eq. (2). Of course, different electric conditions are expected to yield different magnitudes of these contribution, but the path-independent nature of the integral should

not be altered if the closed contour is chosen as  $C_l$  (Fig. 1). A universal formulation for a typical crack  $l$  in its local coordinate system  $(x_1^l, x_2^l)$  with  $\theta_l$  as the orientation angle can always be written as

$$F_{2al}^* = \int_{-a_l}^{a_l} [(w_m^+ - w_m^-) + (w_e^+ - w_e^-)] dx_{1*}^{(l)} \quad (11)$$

where  $F_{2al}^*$  represents the contribution from the surfaces of the  $l$ th crack, the superscripts  $+$  and  $-$  denote the upper and lower boundary values on the crack surfaces, and the subscripts  $m$  and  $e$  refer to the mechanical energy and electric energy, respectively, given by:

$$W_m = \frac{1}{2} \sigma_{ij} \varepsilon_{ij} \quad (12a)$$

$$W_e = -\frac{1}{2} D_i E_i \quad (12b)$$

Eq. (11) and Eqs. (12a) and (12b) will be calculated below by using a technique developed specially for the current situation.

Since  $dy = dx_2 = 0$  on  $\Gamma_1$  and  $\Gamma_2$ , and  $dx = dx_1 = 0$  on  $\Gamma_L$  and  $\Gamma_R$ , the left side of Eq. (10a) becomes

$$\begin{aligned} J_1^\infty = & \int_{\Gamma_1 + \Gamma_2} [(-\sigma_{i2}^\infty n_2 \partial u_i / \partial x) + (-D_2 n_2 \partial \phi / \partial x)] ds + \int_{\Gamma_L + \Gamma_R} (W_m + W_e) dy \\ & + \int_{\Gamma_L + \Gamma_R} [(-\sigma_{i1}^\infty n_1 \partial u_i / \partial x) + (-D_1 n_1 \partial \phi / \partial x)] ds \end{aligned} \quad (13)$$

With that  $n_2 = 1$  on  $\Gamma_1$ ,  $n_2 = -1$  on  $\Gamma_2$ ,  $n_1 = 1$  on  $\Gamma_R$  and  $n_1 = -1$  on  $\Gamma_L$ , (13) can be rewritten as

$$\begin{aligned} J_1^\infty = & \sigma_{i2}^\infty \left[ \int_a^b u_{i,1} dx - \int_d^c u_{i,1} dx \right] + D_2^\infty \left[ \int_a^b \phi_{,1} dx - \int_d^c \phi_{,1} dx \right] \\ & + \left[ \frac{1}{2} \sigma_{ij}^\infty \varepsilon_{ij}^\infty \left( \int_b^c dy - \int_a^d dy \right) \right] - \left[ \frac{1}{2} D_i^\infty E_i^\infty \left( \int_b^c dy - \int_a^d dy \right) \right] \\ & + \sigma_{i1}^\infty \left[ \int_b^c u_{i,1} dy - \int_a^d u_{i,1} dy \right] + D_1^\infty \left[ \int_b^c \phi_{,1} dy - \int_a^d \phi_{,1} dy \right] \end{aligned} \quad (14)$$

Obviously, the third and fourth terms in Eq. (14) vanish because  $[\int_b^c dy - \int_a^d dy] = 0$ , whereas the first term depends on the value of  $[\int_a^b u_{i,1} dx - \int_d^c u_{i,1} dx]$ , the second term on the value of  $[\int_a^b \phi_{,1} dx - \int_d^c \phi_{,1} dx]$ , the fifth term on the value of  $[\int_b^c u_{i,1} dy - \int_a^d u_{i,1} dy]$ , and the sixth term on the value of  $[\int_b^c \phi_{,1} dy - \int_a^d \phi_{,1} dy]$ . It should be mentioned that  $u_{i,1}$  and  $\phi_{,1}$  in the integrals are defined at infinity since the rectangular closed contour has been chosen as large as possible.

Now, the remote displacement field must be linear with respect to both  $x$ - and  $y$ -coordinates so that the uniform strain field at infinity would be maintained. Similarly, the electric potential should also be linear in order that the uniform electric displacement field at infinity is sustained. In fact, the remote uniform mechanical-electric fields do not depend on the configuration of the  $N$  interacting cracks, even if the array of the cracks is not symmetrical with respect to either  $x = 0$  or  $y = 0$ . Therefore, the asymptotic values of  $u_{i,1}$  at infinity should be constant, i.e., the integral  $[\int_a^b u_{i,1} dx - \int_d^c u_{i,1} dx]$  should vanish. Similarly, the asymptotic values of  $\phi_{,1}$  at infinity should also be constant and hence the integral  $[\int_a^b \phi_{,1} dx - \int_d^c \phi_{,1} dx]$  vanishes.

The situation becomes much more clearer when the original problem shown in Fig. 1 is divided into two sub-problems. The first involves no cracks, with linear remote displacement and electric potential fields with respect to both  $x$ - and  $y$ -coordinates; the second involves  $N$  cracks with self-balanced tractions as well as self-balanced electric displacements acting on both surfaces of each individual crack, and no remote loading is applied. The detailed configuration of such subdivision is well-known, and hence is not repeated here. It suffices to mention that the second sub-problem yields zero displacement field at infinity because the stresses

and strains caused by the self-balanced surface tractions have an asymptotic nature with the order of  $r^{-2}$  (for large values of  $r = \sqrt{x^2 + y^2}$ ). Thus, the remote displacement field is only dominated by the first sub-problem, resulting in  $u_{i,1}(\text{on } \Gamma_1) = u_{i,1}(\text{on } \Gamma_2)$ . A similar result holds for the electric field at infinity. These results leads directly to the conclusion that the first, second, fifth and sixth terms in Eq. (14) should all vanish, no matter how many cracks are present in the finite region of an infinite 2-D piezoelectric solid and whether the array of the cracks is symmetrical with respect to  $x = 0$  (or  $y = 0$ ) or not. Therefore, Eq. (3) as a new conservation law of the  $J_1(=J)$  integral has been proved. Its validity will be confirmed further in Section 3 using numerical examples. Similarly, a straightforward manipulation can be given for Eq. (4) representing a new conservation law of the  $J_2$  integral. For brevity, details are not repeated here.

Obviously, such vanishing nature of the vector does not depend on the shape of the cracks enclosed by the closed contour  $C_0$  (Fig. 1). Therefore, other types of discontinuity such as curved cracks, bifurcated cracks, voids with arbitrary shapes, and inclusions, all enclosed by the contour  $C$ , will also satisfy Eqs. (3) and (4). The detailed expressions of the contributions from different types of discontinuity to the vector may of course be different, but the total summation of the contributions should vanish. It is important to note that the manipulations performed hitherto are independent upon the type of the electric boundary condition imposed on the crack surfaces. In other words, the conservation laws are always valid, irregardless of the type of electric boundary condition selected.

### 3. Numerical examples

To prove the conservation laws with numerical examples, an initial attempt has been made by Han and Chen (1999) who considered parallel microcracks oriented in a direction perpendicular to the poling direction of a transversely isotropic piezoelectric material. Therefore, only the  $J_1$ -integral is calculated since the contribution of  $J_{2(l)}^I$  to  $J_{1(l)}$  in Eq. (5) vanishes due to the fact that the orientation angle  $\theta_l \equiv 0$  for this simple array of cracks.

For the problem shown in Fig. 1, the situation is much more complicated than that considered by Han and Chen (1999). The randomly oriented and distributed microcracks are no longer parallel with each other; they also are not necessarily perpendicular to the poling direction of the material. It is then expected that the  $J_{2(l)}^I$  integral in the local system will play an important role as it would be in non-piezoelectric materials (Chen, 2000a). Before this can be verified, it is important to first find an accurate method to calculate numerically  $J_{2(l)}^I$  in the local coordinate system  $(x_1^I, x_2^I)$ , since Herrmann and Herrmann (1981) have shown that, besides the two crack tips of the  $l$ th microcrack, the traction-free surfaces of the  $l$ th microcrack also contribute to  $J_{2(l)}^I$ . Such a method is introduced below.

To calculate  $J_{2(l)}^I$ , a typical crack of length  $2a_l$  is shown in Fig. 2 in a local coordinate system, where a special closed contour is introduced:

$$C_l = C_l^- + C_l^R - C_l^+ - C_l^L \quad (15)$$

where the superscripts  $+$  and  $-$  refer to the upper and lower surfaces of the crack, R and L refer to the right and left tips of the crack, and  $C_l^R$  and  $C_l^L$  denote two infinitely small circles with the radius  $\rho \rightarrow 0$  (Fig. 2), respectively.

The calculation of  $J_{2(l)}^I$  along  $C_l$  can be divided into two parts, one contributed by both tips of the crack along path  $C_l^R$  and  $C_l^L$ , and the other induced from the crack surfaces along path  $C_l^+$  and  $C_l^-$ . The special technique proposed by the present authors and co-workers (Chen and Ma, 1997) for anisotropic elastic materials is adopted here. The integration of  $J_2^I$  along an infinitely small circle surrounding a crack tip may be obtained by using the following ERR relationship (Chen and Ma, 1997):

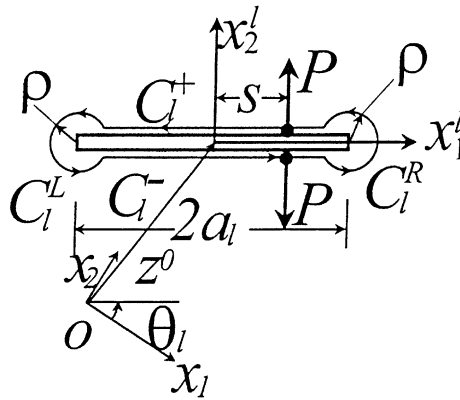


Fig. 2. Special closed contour for a single crack in local coordinates.

$$J_2^l = -g = \lim_{\Delta \rightarrow 0} \frac{-1}{2\Delta} \int_0^\Delta \sigma_{i1}(\Delta - \rho) u_i(\rho) d\rho \quad (i = 1, 2) \quad (16)$$

where  $J_2^l$  refers to the contribution from a single crack tip to the  $J_2$ -integral and  $g$  denotes the ERR as defined by Chen and Ma (1997).

The validity of Eq. (16) will be checked against numerical results presented below. As regards the contribution of both surfaces of the crack to  $J_{2(l)}^l$ , there are no special difficulties to be overcome as long as all mechanical and electric quantities along  $C^+$  and  $C^-$  are known a priori. It will be shown in Section 3.1 that these quantities can be determined by employing the complex function method and performing the Chebyshev numerical integration.

### 3.1. Pseudo-traction-electric-displacement method

The interaction problem among  $N$  cracks in an anisotropic piezoelectric material (Fig. 1) can be solved by extending the pseudo-traction method developed by Horii and Nemat-Nasser (1985, 1987) for solving multiple crack interaction problems in non-piezoelectric materials. The key here is to decompose the original problem into  $N$  sub-problems, each containing one single crack with pseudo-tractions and pseudo-electric-displacement assigned to both of its surfaces. Once the fundamental solutions for a single crack loaded by concentrated tractions and concentrated electric displacement on both crack surfaces are found, the following set of Fredholm integral equations can be derived from simple superposition (Han and Chen, 1999):

$$\mathbf{P}^l(s) + \sum_{j=0}^N \sigma^{lj}(s) = 0 \quad (l = 1, 2, 3, \dots, N, j \neq l) \quad (17)$$

Here,  $\mathbf{P}^l(s)$  denotes a function vector with the unknown pseudo-tractions and electric-displacement on both surfaces of the  $l$ th crack as its elements, and  $\sigma^{l0}(s)$  refers to the stresses and electric displacement arising from the remote loading  $\sigma^\infty$  and  $D_2^\infty$ , given by

$$\sigma^{l0}(s) = \mathbf{R}_1 \sigma^\infty \quad (18)$$

where

$$\sigma^\infty = [\sigma_{12}^\infty, \sigma_{22}^\infty, 0, D_2^\infty]^T \quad (19)$$



$$\mathbf{R}_1 = \begin{bmatrix} \frac{1}{2} \cos 2\theta & \frac{1}{2} \sin 2\theta & 0 & 0 \\ -\frac{1}{2} \sin 2\theta & \cos^2 \theta & 0 & 0 \\ 0 & 0 & \cos \theta & 0 \\ 0 & 0 & 0 & \cos \theta \end{bmatrix} \quad (20)$$

Furthermore, in Eq. (17),  $\sigma^{lj}(s)$  denotes the contribution of the rest of the microcracks to the  $l$ th crack:

$$\sigma^{lj}(s) = \int_{-a_l}^{a_l} \mathbf{F}^{lj}(s, x) \mathbf{P}^j(x) dx \quad (j \neq l) \quad (21)$$

where

$$\mathbf{P}^j(x) = [P_1^j(x), P_2^j(x), P_3^j(x), D_2^j(x)]^T \quad (22)$$

and  $\mathbf{F}^{lj}(s, x)$  is the influence function on the  $l$ th crack induced from the  $j$ th crack (Han and Chen, 1999).

The integral equation (17) can be solved numerically by expanding  $\mathbf{P}^{(l)}(s)$  into the second Chebyshev polynomial:

$$\mathbf{P}^l(s) = \sum_{k=0}^M \mathbf{G}_k^l \mathbf{U}_k(s/a_l) \quad (23)$$

where

$$\mathbf{G}_k^l = \int_{-1}^1 2\sqrt{1-s^2} \mathbf{P}^l(a_l x) \mathbf{U}_k(x) / \pi dx \quad (24)$$

and  $\mathbf{U}_k(s/a_l)$  is the second Chebyshev polynomial with order  $k$ , and  $M$  is an integer number controlling the numerical accuracy.

Once Eq. (17) is solved, the SIFs and the electric displacement intensity factor (EDIF) at the right and left tips of the  $l$ th crack can be straightforwardly calculated as:

$$\mathbf{K}^{lR} = - \int_{-a_l}^{a_l} \mathbf{P}^l(s) (a_l + s)^{1/2} (a_l - s)^{-1/2} (\pi a_l)^{-1/2} ds \quad (25)$$

$$\mathbf{K}^{lL} = - \int_{-a_l}^{a_l} \mathbf{P}^l(s) (a_l - s)^{1/2} (a_l + s)^{-1/2} (\pi a_l)^{-1/2} ds \quad (26)$$

$$\text{where } \mathbf{K}^{lR} = [K_{II}^{lR}, K_I^{lR}, K_{III}^{lR}, K_e^{lR}] \quad (27)$$

$$\mathbf{K}^{lL} = [K_{II}^{lL}, K_I^{lL}, K_{III}^{lL}, K_e^{lL}] \quad (28)$$

Here, the subscripts I, II, and III refer to the Mode I, Mode II, and Mode III SIFs, respectively, the subscript e denotes to the EDIF, and the subscripts  $l$ , R, and L represent separately the  $l$ th crack, its right and left tips.

The first component of the  $J_k$ -vector evaluated in the local coordinate system  $(x_1^l, x_2^l)$  originated at the center of the  $l$ th crack can be calculated as (see, for example, Suo et al. 1992)

$$J_1^{lR} = \frac{1}{4} (\mathbf{K}^{lR})^T \mathbf{H} \mathbf{K}^{lR} \quad (29)$$

$$J_1^{lL} = \frac{1}{4} (\mathbf{K}^{lL})^T \mathbf{H} \mathbf{K}^{lL} \quad (30)$$

On the other hand, from Eq. (16), it can be shown that the second component is given by:

$$J_2^{/R} = \frac{1}{4}(\mathbf{K}^{/R})^T \mathbf{X} \mathbf{H} \mathbf{K}^{/R} \quad (31)$$

$$J_2^{/L} = -\frac{1}{4}(\mathbf{K}^{/L})^T \mathbf{X} \mathbf{H} \mathbf{K}^{/L} \quad (32)$$

where the matrix  $\mathbf{H}$  is

$$\mathbf{H} = 2\text{Re}(i\mathbf{A}\mathbf{B}^{-1}) \quad (33)$$

for which the matrices  $\mathbf{X}$ ,  $\mathbf{A}$ , and  $\mathbf{B}$  can be found in Suo et al. (1992).

Note that  $J_2^{/R}$  and  $J_2^{/L}$  only represent contributions of the right and left tips of the  $l$ th crack to  $J_{2(l)}^l$  in the local coordinate system  $(x_1^l, x_2^l)$ ; they are calculated along  $C_l^R$  and  $C_l^L$  as  $\rho \rightarrow 0$  (Fig. 2). To calculate the full value of  $J_{2(l)}^l$ , the contribution from both surfaces  $C_l^+$  and  $C_l^-$  must included. However, since the integral equation (17) has already been solved numerically so that all the mechanical and electric quantities on the surfaces of the  $l$ th crack are now determined, the contribution of crack surfaces can be calculated numerically by using Eq. (11). Finally, the total contribution of the  $l$ th crack to the second component of the  $J_k$ -vector in the local coordinate system  $(x_1^l, x_2^l)$  is obtained as

$$\begin{aligned} J_{2(l)}^l &= J_2^{/R} + J_2^{/L} + J_2^{lf} \\ &= \frac{1}{4}(\mathbf{K}^{/R})^T \mathbf{X} \mathbf{H} \mathbf{K}^{/R} - \frac{1}{4}(\mathbf{K}^{/L})^T \mathbf{X} \mathbf{H} \mathbf{K}^{/L} + \int_{-a_l}^{a_l} (W^+ - W^-) ds \end{aligned} \quad (34)$$

The contribution of the  $l$ th crack to the vector in the global system can then be evaluated by using the projected relations (5) and (6).

### 3.2. Numerical results

Although the results presented above are derived for general anisotropic piezoelectric materials, for simplicity, the numerical results to be given below will be limited to a transversely isotropic piezoelectric material, i.e., the PTZ-4 ceramic, with its material constants given in Table 1. It is assumed that the poling direction of the ceramic is parallel to the  $x_2$ -axis (Fig. 1).

First, the formulation for calculating the  $J_2$ -integral induced only from one tip of a single crack embedded in the PTZ-4 ceramic is examined. Table 2 shows that the values derived by using Eq. (2) coincide well with those derived by using the ERR relation (16), no matter how the Mode I and Mode II SIFs and the EDIF at infinity are combined. Judging from the results of Table 2, one may conclude that the derivative procedure, i.e., Eq. (16), is not only valid for anisotropic elastic materials (Chen and Ma, 1997), but also valid for transversely isotropic piezoelectric ceramics.

The conservation laws of the  $J_k$ -vector, i.e., Eqs. (3) and (4), are examined next by introducing an array of four microcracks (Fig. 3), each of length  $2a$ , with orientations and locations specified in Table 3. Here,  $d_l$ ,  $\varphi_l$ ,  $\theta_l$ , and  $x_{1(l)}$ , and  $x_{2(l)}$  ( $l = 1, 2, 3$ , and  $4$ ) denote separately the location distance from the origin, location

Table 1  
Material constants of PTZ-4 ceramics

$C_{11}$	$C_{12}$	$C_{13}$	$C_{33}$	$C_{44}$	Unit
1.4020	0.7892	0.7565	1.1577	0.2525	$(\text{N/m}^2) \times 10^{11}$
$e_{31}$ −5.2677	$e_{33}$ 15.4455	$e_{15}$ 12.0000			$(\text{C/m}^2)$
$w_{11}$ 0.6359	$w_{33}$ 0.5523				$(\text{C/Vm}) \times 10^{-8}$

Table 2

Numerical examination for the  $J_2$ -integral (2) and the ERR  $g$  in Eq. (16) under combined mechanical and electric loading conditions

$K_{II}/K_I$	$K_I/K_I$	$K_{III}/K_I$	$K_e^N$	$r = 0.1$		$r = 1.0$	
				$J_2^I/J_1$	$-g/J_1$	$J_2^I/J_1$	$-g/J_1$
0.5	0.5	0.0	0.0	1.31667	1.31667	1.31667	1.31667
0.5	1.0	0.0	0.0	1.06462	1.06462	1.06462	1.06462
1.0	0.5	0.0	0.0	1.04227	1.04227	1.04227	1.04227
0.5	0.5	0.0	1.0	−0.18119	−0.18119	−0.18119	−0.18119
1.0	1.0	0.0	1.0	−5.37522	−5.37522	−5.37522	−5.37522

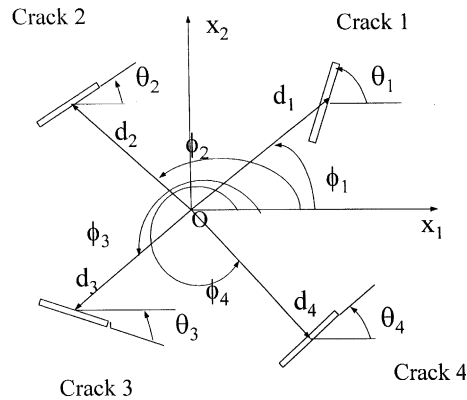
 $(K_e^N = K_e/(10^{-8}K_ICN^{-1}))$ .

Fig. 3. Geometry and conventions for four interacting cracks.

Table 3

Orientations and relative positions of four microcracks

$l$	1	2	3	4
$\theta_l$	Variable	$-25^\circ$	$55^\circ$	$30^\circ$
$\phi_l$	$45^\circ$	$140^\circ$	$260^\circ$	$340^\circ$
$d_l$	1.6a	1.4a	1.3a	1.6a
$x_{1(l)}$	1.1314a	−1.0725a	−0.2257a	1.5035a
$x_{2(l)}$	1.1314a	0.9000	−1.2803a	−0.5472a

angle, orientation angle, and position coordinates of the center of the  $l$ th microcrack in the global coordinate system  $(x_1, x_2)$ . Without loss of generality, three types of remote loading condition are considered: (i) pure Mode I mechanical loading, with  $\sigma_{12}^\infty = \sigma_{32}^\infty = D_2^\infty = 0$  and  $\sigma_{22}^\infty > 0$ ; (ii) Mode I mechanical loading combining with positive electric loading, with  $\sigma_{12}^\infty = \sigma_{32}^\infty = 0$ ,  $\sigma_{22}^\infty > 0$ , and  $D_2^\infty = 10^{-8}\sigma_{22}^\infty C/N$ ; (iii) Mode I mechanical loading combining with negative electric loading, with  $\sigma_{12}^\infty = \sigma_{32}^\infty = 0$ ,  $\sigma_{22}^\infty > 0$ , and  $D_2^\infty = -10^{-8}\sigma_{22}^\infty C/N$ . Numerical experiments reveal that a value of 41 for the total number of terms  $M$  in the Chebyshev polynomial (23) yields satisfactory accuracy for all three types of remote loading condition;  $M = 41$  is therefore used in all subsequent numerical calculations.

For type (ii) remote loading condition (Mode I mechanical loading combining with positive electric loading), Table 4 shows the values of  $J_{1(l)}$  ( $l = 1, 2, 3, 4$ ) contributed by the four microcracks to the  $J$ -integral. Here, the  $J_k$ -vector is normalized by

Table 4

Values of  $J_{1(l)}/J_0$  ( $l = 1, 2, 3, 4$ ) under combined mechanical and positive electric loading (type (ii) loading)

$\theta_1$	0°	30°	60°	90°	120°	150°
$J_{1(1)}/J_0$	−0.0200	−0.2377	−0.0594	0.0032	−0.0536	−0.0020
$J_{1(2)}/J_0$	−0.0123	0.2293	0.0475	−0.0415	−0.0824	−0.0993
$J_{1(3)}/J_0$	0.0763	0.0960	0.1401	0.1278	0.0964	0.0774
$J_{1(4)}/J_0$	−0.0439	−0.0875	−0.1282	−0.0895	0.0396	0.0239
$\sum J_{1(l)}/J_0$	0.0000	0.0000	0.0000	0.0000	0.0000	0.0000

Table 5

Values of  $J_{2(l)}/J_0$  ( $l = 1, 2, 3, 4$ ) under combined mechanical and negative electric loading (type (iii) loading)

$\theta_1$	0°	30°	60°	90°	120°	150°
$J_{2(1)}/J_0$	−0.1308	−0.0281	0.1020	0.0114	−0.0121	0.0144
$J_{2(2)}/J_0$	0.2673	0.1305	−0.0379	−0.0074	0.0386	0.1247
$J_{2(3)}/J_0$	−0.2342	−0.2310	−0.2538	−0.2831	−0.2639	−0.2419
$J_{2(4)}/J_0$	0.0977	0.1286	0.1897	0.2791	0.2374	0.1028
$\sum J_{2(l)}/J_0$	0.0000	0.0000	0.0000	0.0000	0.0000	0.0000

$$J_0 = \frac{1}{4}(\mathbf{K}_0)^T \mathbf{H}_0 \mathbf{K}_0 \quad (35)$$

where  $\mathbf{K}_0$  and  $\mathbf{H}_0$  are the fundamental solutions for a single crack, oriented parallel to the  $x_1$ -axis, subjected to the same type (ii) loading condition. The orientation angle  $\theta_1$  of the first microcrack in Table 3 is taken to be 0°, 30°, 60°, 90°, 120°, and 150°, respectively. It is seen from Table 4 that the summation of  $J_{1(l)}$  ( $l = 1, 2, 3, 4$ ) indeed vanishes, confirming the conservation law (3). Table 5 presents the numerical results for  $J_{2(l)}$  under type (iii) loading condition (Mode I mechanical loading combining with the negative electric loading). Again, the summation of  $J_{2(l)}$  ( $l = 1, 2, 3, 4$ ) is seen to vanish, as suggested by the conservation law (4). Thus, the conservation laws of the  $J_k$ -vector (3) and (4) for non-piezoelectric materials (Chen and Hasebe, 1998; Chen, 2000a) have been shown to be equally valid for multiple crack interaction problems in piezoelectric materials. That is, the summation of the contributions induced from all the microcracks to each component of the  $J_k$ -vector always vanishes, even though the values of  $J_{1(l)}$  and  $J_{2(l)}$  for each individual microcrack are far from zero due to strong crack interactions. Consequently, the conservation laws as formulated by Eqs. (3) and (4) provide not only a consistency check of the numerical results presented in this section but also a powerful tool to examine the validity of the ‘pseudo-traction-electric-displacement’ method developed in Section 3.1.

#### 4. Applications: two arbitrarily located interacting cracks

In this section, the pseudo-traction-electric-displacement method is used to study in detail the interaction effect between two arbitrarily located microcracks (Fig. 4) on crack tip parameters such as SIFs and EDIF. The two cracks are embedded in an infinitely large PTZ-4 ceramic. Crack 1 is always parallel to the global coordinate axis  $x_1$ , whereas the position and orientation of crack 2 with respect to crack 1 are arbitrary. Let  $2a$  denote the length of the microcracks, and let  $\theta_2$ ,  $\phi_2$  and  $d_{12}$  represent the orientation angle, location angle, and distance from tip  $A$  of crack 1 to the center  $O_2$  of crack 2, respectively. For illustration, the normalized distance between the two crack centers is taken as  $d_{12}/a = 1.2$ , the orientation angle of crack 2 is assumed to be  $\phi_2 = 60^\circ$ , whilst the location angle of crack 2,  $\theta_2$ , varies from 0° to 180°. All three types of

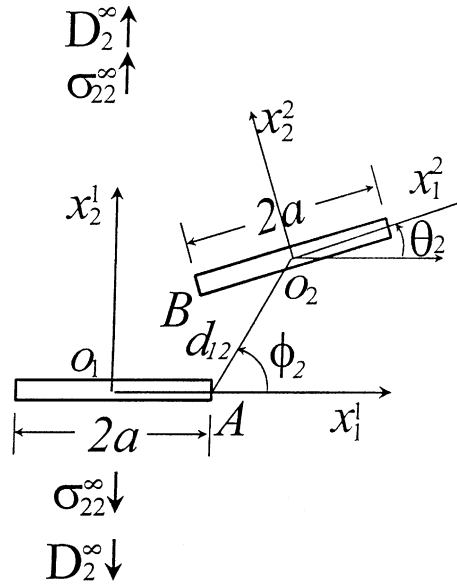


Fig. 4. Geometry and conventions for two arbitrarily located and oriented interacting cracks.

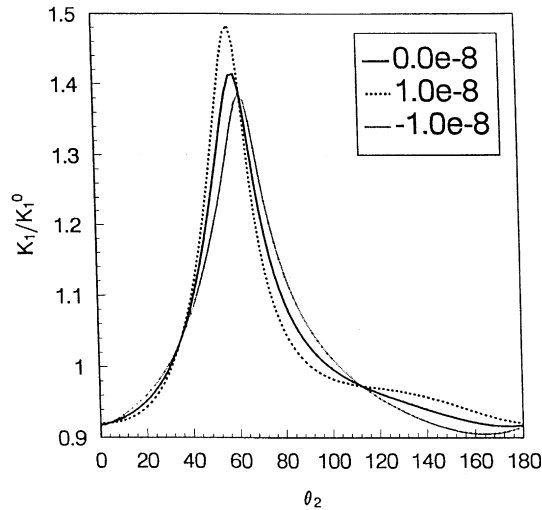


Fig. 5. Normalized Mode I SIF at tip  $A$  of crack 1,  $K_1/K_1^0$ , plotted as a function of its orientation angle of crack 2,  $\theta_2$ , for type (i), (ii), and (iii) loading conditions ( $D_2^\infty/\sigma_{22}^\infty = 0, 10^{-8}, -10^{-8} C/N$ , respectively).

remote loading condition discussed in the previous sections are examined, with  $D_2^\infty/\sigma_{22}^\infty = 0, 10^{-8}, -10^{-8} C/N$ , respectively.

Fig. 5 plots the normalized Mode I SIF at the tip  $A$  of crack 1 (see Fig. 4) as a function of the location angle  $\theta$  of crack 2 for types (i), (ii), and (iii) loading conditions. Although the trends are in general similar, there is considerable deviation of the dotted lines corresponding to types (ii) and (iii) loading conditions from the solid line corresponding to the pure mechanical loading (type (i)). Moreover, the positive electric loading (type (ii)) and negative electric loading (type (iii)) have opposite effects on the SIF. That is, for

certain values of  $\theta_2$ , e.g., the range between  $3^\circ$  and  $34^\circ$  or the range between  $63^\circ$  and  $112^\circ$ , the positive electric loading tends to decrease the SIF whereas the negative electric loading tends to increase the SIF. For other ranges of  $\theta_2$ , e.g., the range between  $34^\circ$  and  $62^\circ$  or the range between  $112^\circ$  and  $180^\circ$ , the roles of the positive and negative electric loading reverse. Four electric-neutral angles (ENA),  $3^\circ$ ,  $34^\circ$ ,  $63^\circ$  and  $112^\circ$ , can be identified on Fig. 5, where neither positive nor negative electric loading influences the value of SIF.

Of great interest is the influence of remote electric loading on the position of the maximum interacting effect angle (MIEA) (Fig. 5), which is defined here as the location angle of crack 2 that leads to the maximum interacting effect between the two cracks. Fig. 5 suggests that the electric loading shifts the value of MIEA, which is about  $60^\circ$  under pure mechanical loading (type (i)): a positive electric loading decreases MIEA but increases the crack interaction effect; a negative electric loading increases MIEA whereas reduces the interacting effect. These are apparently non-linear effects of the electric loading on SIF. In other words, although the positive and negative electric loadings have opposite effects on SIF, the effects are not proportional. Fig. 6 presents the normalized Mode I SIF at the tip  $B$  of crack 2 as a function of  $\theta$ . The trends are similar to those discussed above for Fig. 5.

The results shown in Figs. 5 and 6 for the two interacting cracks problem are quite different from those given in Sosa (1991, 1992) for the single crack problem. Sosa (1991, 1992) found that the remote electric loading has no influence on the Mode I SIF at the tip of a single crack embedded in an infinitely large piezoelectric solid. In the present problem with two interacting cracks, the second crack centered at  $O_2$  (Fig. 4) not only releases stresses in the vicinity of tip  $A$  of the first crack centered at  $O_1$ , but also disturbs the near-tip electric field at  $A$ . Similarly, the stress and electric fields in the vicinity of tip  $B$  of crack 2 are disturbed by the presence of crack 1. These are believed to be the reasons behind the coupling between electric loading and Mode I SIF for strongly interacting cracks.

The EDIF at crack tips  $A$  and  $B$  are shown in Figs. 7 and 8 as functions of  $\theta$ , respectively. Again, it is seen that the positive and negative electric loadings have opposite effects on EDIF. However, in contrast to the case of Mode I SIF (Figs. 5 and 6), their influence on EDIF is apparently proportional because the mechanical loading has little influence on EDIF (see the solid lines in Figs. 7 and 8). The maximum influence of remote electric loading on EDIF occurs at about  $62^\circ$  for tip  $A$  (Fig. 7) and at about  $55^\circ$  for tip  $B$  (Fig. 8). Moreover, the influence of electric loading on EDIF depends strongly upon the orientation of the second crack. An electric neutral angle of about  $90^\circ$ , at which neither positive nor negative electric loading has influence on the EDIF at tip  $B$ , is seen to exist in Fig. 8. It corresponds to the case that crack 2 is

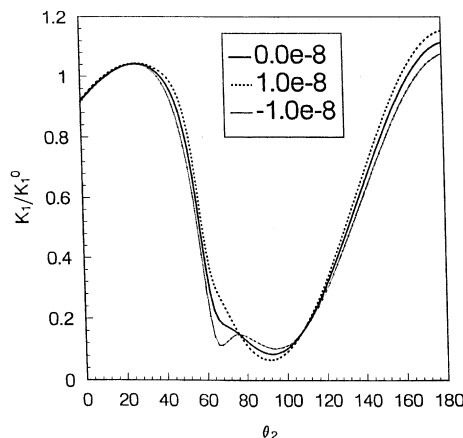


Fig. 6. Normalized Mode I SIF at tip  $B$  of crack 2,  $K_I/K_I^0$ , plotted as a function of its orientation angle of crack 2,  $\theta_2$ , for type (i), (ii), and (iii) loading conditions ( $D_2^\infty/\sigma_{22}^\infty = 0, 10^{-8}, -10^{-8} \text{ C/N}$ , respectively).

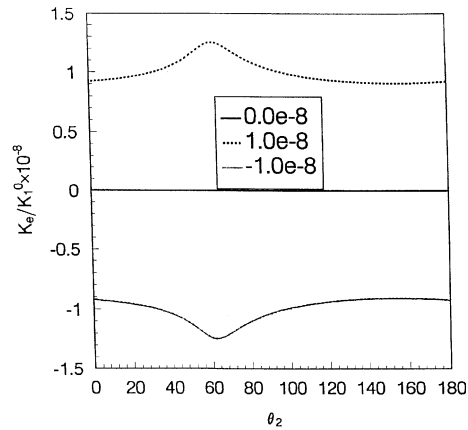


Fig. 7. Normalized EDIF at tip *A* of crack 1,  $K_e/K_1^0$ , plotted as a function of its orientation angle of crack 2,  $\theta_2$ , for type (i), (ii), and (iii) loading conditions ( $D_2^\infty/\sigma_{22}^\infty = 0, 10^{-8}, -10^{-8} C/N$ , respectively).

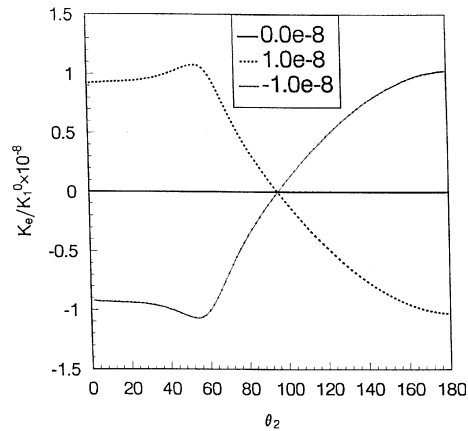


Fig. 8. Normalized EDIF at tip *B* of crack 2,  $K_e/K_1^0$ , plotted as a function of its orientation angle of crack 2,  $\theta_2$ , for type (i), (ii), and (iii) loading conditions ( $D_2^\infty/\sigma_{22}^\infty = 0, 10^{-8}, -10^{-8} C/N$ , respectively).

parallel both to the poling direction of the piezoelectric material and to the direction of remote electric loading. However, no such electric neutral angle exists in Fig. 7 for tip *A* since crack 1 is always perpendicular to the poling direction as well as the electric loading direction.

## 5. Conclusions

Based on the results presented in this paper, the following conclusions can be summarized:

(1) The  $J_2$ -integral in piezoelectric materials can be divided into two separated parts, corresponding to the mechanical and electric quantities, although both are coupled in the constitutive equations of the materials.

(2) The conservation laws (3) and (4) found in non-piezoelectric materials also hold for piezoelectric materials. In other words, the total contributions to both components of the  $J_k$ -vector due to a cloud of randomly distributed, interacting microcracks in 2-D-piezoelectric materials vanish, provided that the closed contour along which the integration is performed encloses all the microcracks (or, equivalently, no other discontinuities exist outside of the closed contour).

(3) The conservation laws (3) and (4) can be used as a powerful tool to check the validity of numerical results and the corresponding numerical methods for strongly interacting multiple crack problems in piezoelectric materials, although they only provide two necessary conditions rather than sufficient conditions.

(4) The remote electric displacement loading has significant influence on the magnitudes of crack tip SIFs and EDIF. However, the trends exhibited by the SIFs at each crack tip subjected to combined mechanical and electric loading are similar to those under pure mechanical loading.

(5) Positive and negative electric loadings impose opposite effects on crack tip SIFs for interacting cracks. The influence is strongly non-linear due to crack interaction, depending on the relative locations and orientations of the cracks. For certain crack arrays, a positive electric loadings increases the crack tip SIFs whereas a negative electric loading decreases the crack tip SIFs. The reverse is true for other crack arrays. In general, both electric and mechanical loadings can have profound effects on crack tip SIFs: neither can be neglected.

(6) In contrary to the crack tip SIFs, the effect of remote electric loadings on crack tip EDIF is linear, because the remote mechanical loadings have little or no influence on EDIF. However, in the presence of remote electric loadings (positive or negative), the variation trends exhibited by the EDIF as the positions and orientations of the cracks are varied are rather complicated, depending strongly on the orientation of each crack relative to the poling direction of the piezoelectric. Further research is needed to fully understand the mutual shielding effect in interacting cracks.

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